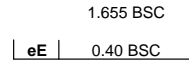
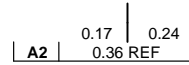
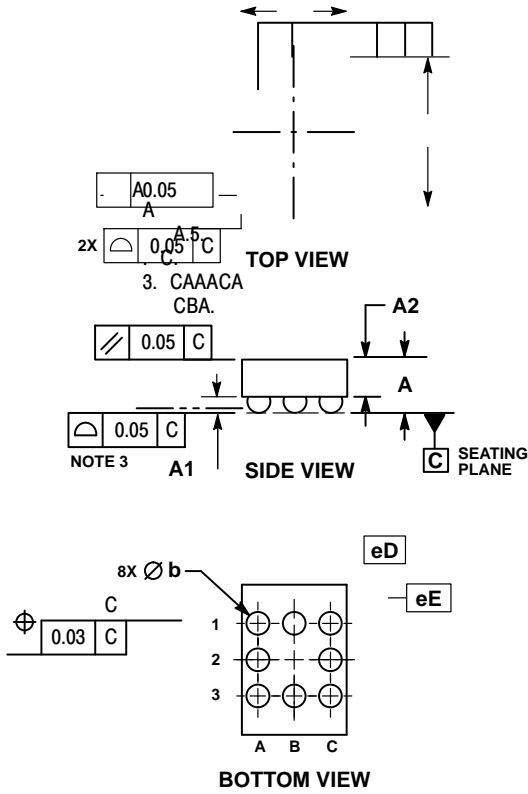




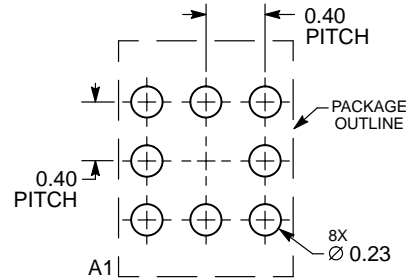
SCALE 4:1

WLCSP8, 1.155x1.655
 CASE 567DH
 ISSUE O

DATE 12 JAN 2012



RECOMMENDED SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.